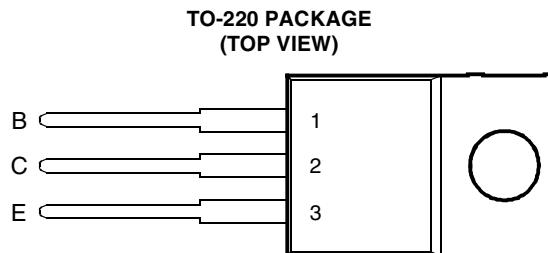


- Designed for Complementary Use with BD895A, BD897A and BD899A
- 70 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Minimum  $h_{FE}$  of 750 at 3V, 3A



Pin 2 is in electrical contact with the mounting base.

MDTRACA

### absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT
Collector-base voltage ( $I_E = 0$ )	$V_{CBO}$	-45 -60 -80	V
Collector-emitter voltage ( $I_B = 0$ )	$V_{CEO}$	-45 -60 -80	V
Emitter-base voltage	$V_{EBO}$	-5	V
Continuous collector current	$I_C$	-8	A
Continuous base current	$I_B$	-0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)	$P_{tot}$	70	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)	$P_{tot}$	2	W
Operating free-air temperature range	$T_A$	-65 to +150	°C
Operating junction temperature range	$T_j$	-65 to +150	°C
Storage temperature range	$T_{stg}$	-65 to +150	°C

NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.56 W/°C.

2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

### PRODUCT INFORMATION

**electrical characteristics at 25°C case temperature (unless otherwise noted)**

PARAMETER	TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = -100 \text{ mA}$	$I_B = 0$	(see Note 3)	BD896A BD898A BD900A	-45 -60 -80		V
$I_{CEO}$ Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$	$I_B = 0$		BD896A		-0.5	
	$V_{CE} = -30 \text{ V}$	$I_B = 0$		BD898A		-0.5	
	$V_{CE} = -40 \text{ V}$	$I_B = 0$		BD900A		-0.5	
$I_{CBO}$ Collector cut-off current	$V_{CB} = -45 \text{ V}$	$I_E = 0$		BD896A		-0.2	
	$V_{CB} = -60 \text{ V}$	$I_E = 0$		BD898A		-0.2	
	$V_{CB} = -80 \text{ V}$	$I_E = 0$		BD900A		-0.2	
	$V_{CB} = -45 \text{ V}$	$I_E = 0$	$T_C = 100^\circ\text{C}$	BD896A		-2	
	$V_{CB} = -60 \text{ V}$	$I_E = 0$	$T_C = 100^\circ\text{C}$	BD898A		-2	
	$V_{CB} = -80 \text{ V}$	$I_E = 0$	$T_C = 100^\circ\text{C}$	BD900A		-2	
$I_{EBO}$ Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$	(see Notes 3 and 4)			-2	mA
$h_{FE}$ Forward current transfer ratio	$V_{CE} = -3 \text{ V}$	$I_C = -4 \text{ A}$	(see Notes 3 and 4)	750			
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = -16 \text{ mA}$	$I_C = -4 \text{ A}$	(see Notes 3 and 4)			-2.8	V
$V_{BE(on)}$ Base-emitter voltage	$V_{CE} = -3 \text{ V}$	$I_C = -4 \text{ A}$	(see Notes 3 and 4)			-2.5	V
$V_{EC}$ Parallel diode forward voltage	$I_E = -8 \text{ A}$	$I_B = 0$				-3.5	V

NOTES: 3. These parameters must be measured using pulse techniques,  $t_p = 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

**thermal characteristics**

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta,JC}$ Junction to case thermal resistance			1.79	°C/W
$R_{\theta,JA}$ Junction to free air thermal resistance			62.5	°C/W

**resistive-load-switching characteristics at 25°C case temperature**

PARAMETER	TEST CONDITIONS <sup>†</sup>			MIN	TYP	MAX	UNIT
$t_{on}$ Turn-on time	$I_C = -3 \text{ A}$	$I_{B(on)} = -12 \text{ mA}$	$I_{B(off)} = 12 \text{ mA}$		1		μs
$t_{off}$ Turn-off time	$V_{BE(off)} = 3.5 \text{ V}$	$R_L = 10 \Omega$	$t_p = 20 \mu\text{s}, dc \leq 2\%$		5		μs

<sup>†</sup> Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

**PRODUCT INFORMATION**

AUGUST 1993 - REVISED SEPTEMBER 2002  
Specifications are subject to change without notice.

## TYPICAL CHARACTERISTICS

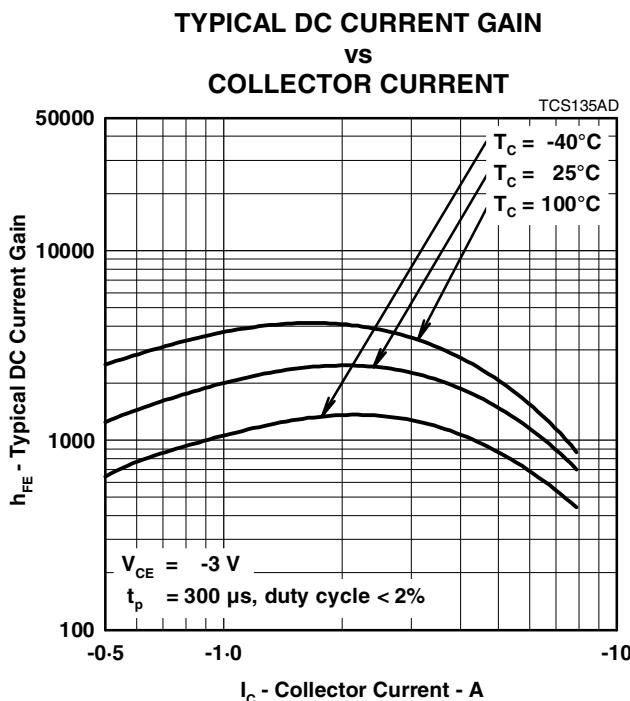


Figure 1.

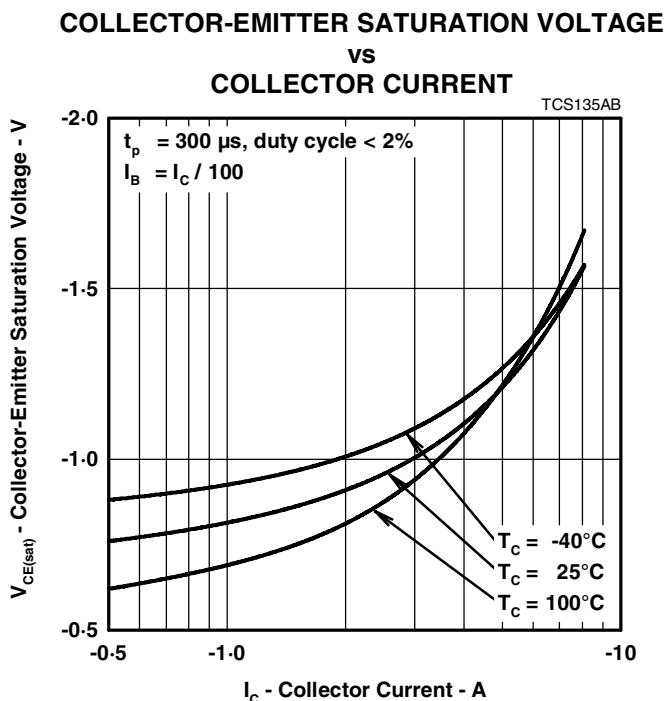


Figure 2.

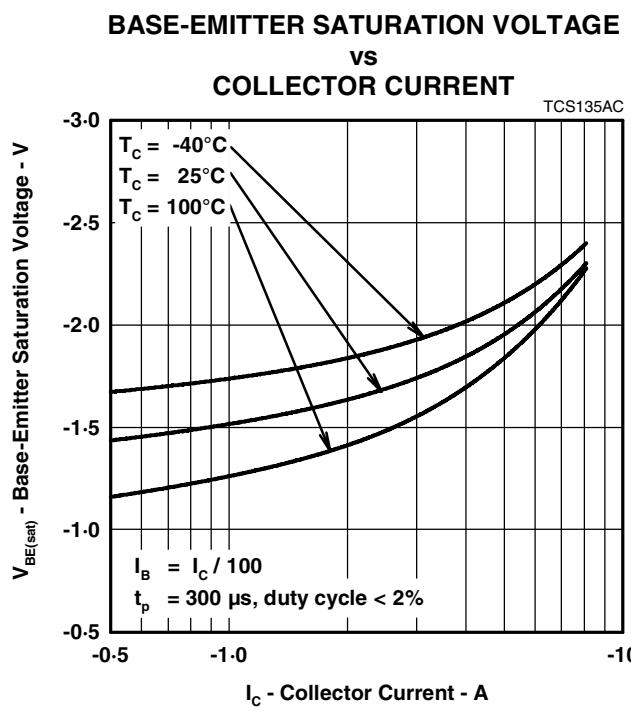


Figure 3.

**PRODUCT INFORMATION**

AUGUST 1993 - REVISED SEPTEMBER 2002  
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### MAXIMUM SAFE OPERATING REGIONS

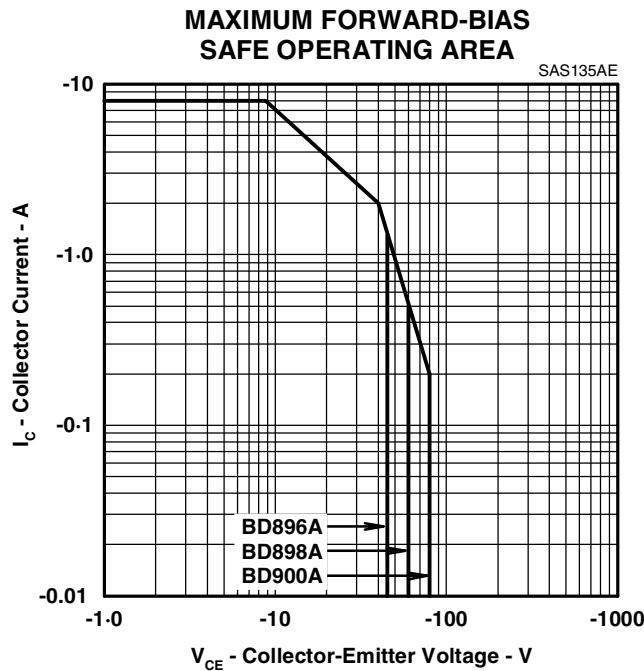


Figure 4.

### THERMAL INFORMATION

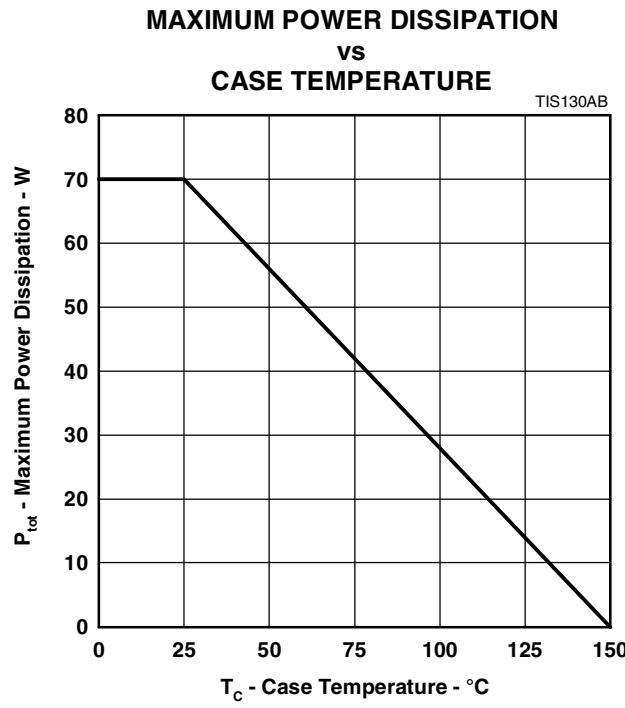


Figure 5.

### PRODUCT INFORMATION

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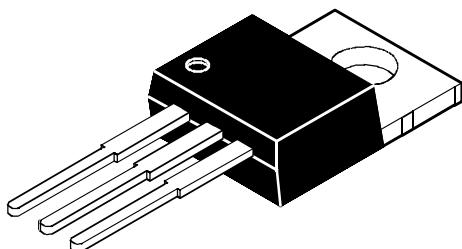
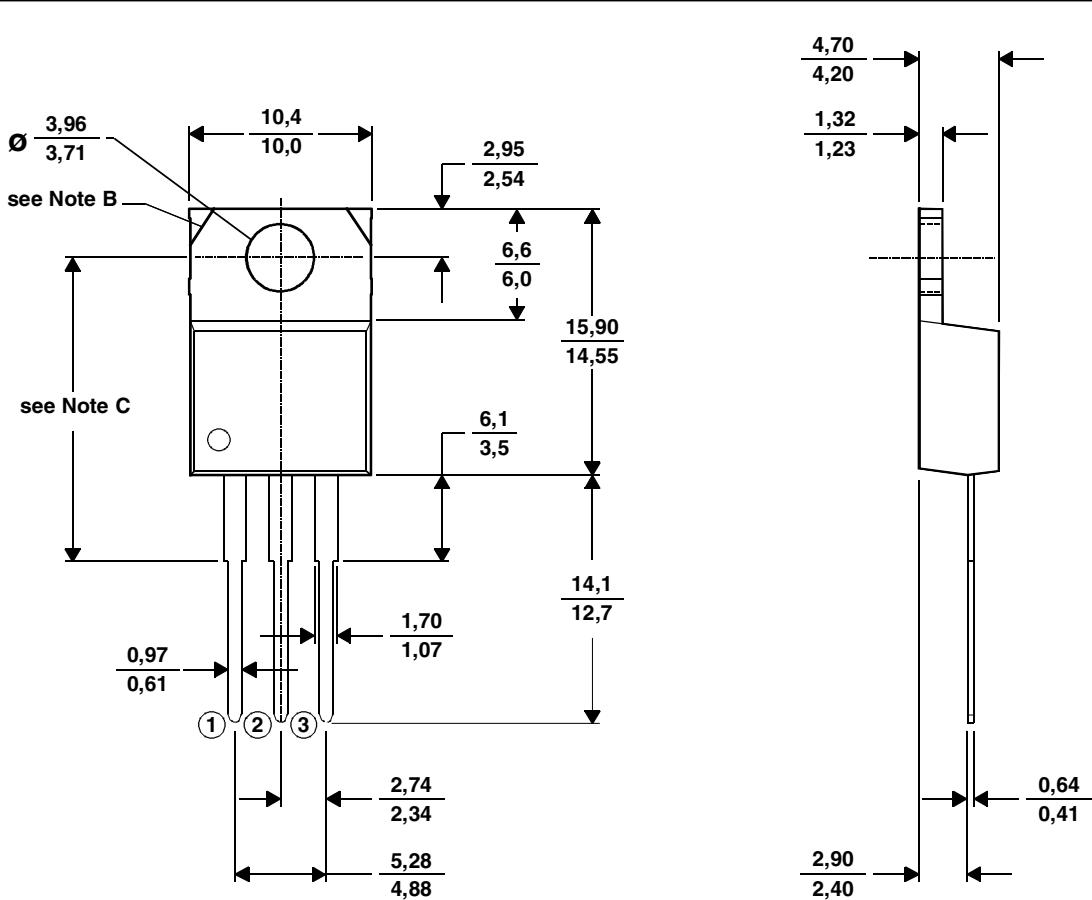
## MECHANICAL DATA

## TO-220

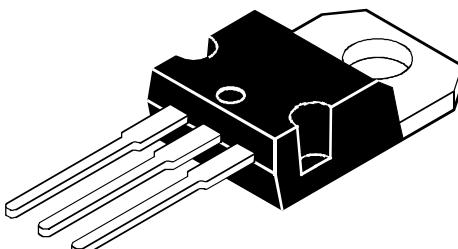
## 3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.

TO220



VERSION 1



VERSION 2

ALL LINEAR DIMENSIONS IN MILLIMETERS

NOTES: A. The centre pin is in electrical contact with the mounting tab.

MDXXBE

B. Mounting tab corner profile according to package version.

C. Typical fixing hole centre stand off height according to package version.

Version 1, 18.0 mm. Version 2, 17.6 mm.

## PRODUCT INFORMATION